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03-27-01

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Patent Application of: Kie Y. Ahn et al.

Title: METHODS FOR MAKING COPPER AND OTHER METAL INTERCONNECTIONS IN
INTEGRATED CIRCUITS

Attorney Docket No.: 303.459US2

JCG29 U.S. Pro
09/81747
03/26/01

PATENT APPLICATION TRANSMITTAL

BOX PATENT APPLICATION

Commissioner for Patents
Washington, D.C. 20231

We are transmitting herewith the following attached items and information (as indicated with an "X"):

Return postcard.

DIVISIONAL of prior Patent Application No. 09/032,197 (under 37 CFR § 1.53(b)) comprising:

Specification (18 pgs, including claims numbered 1 through 38 and a 1 page Abstract).

Formal Drawing(s) (3 sheets).

Copy of signed Declaration (6 pgs) from prior application.

Copy of Power of Attorney from prior application (1 pg.)

Incorporation by Reference: *The entire disclosure of the prior application, from which a copy of the oath or declaration is supplied herewith, is considered as being part of the disclosure of the accompanying application and is hereby incorporated by reference therein.*

Check in the amount of \$710.00 to pay the filing fee.

Prior application is assigned of record to Micron Technology, Inc..

Information Disclosure Statement (1 pgs), Form 1449 (9 pgs). References NOT enclosed, cited in prior application.

Preliminary Amendment (1 pgs).

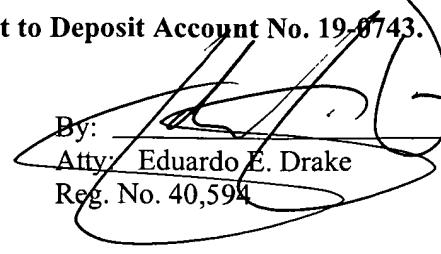
The filing fee has been calculated below as follows:

	No. Filed	No. Extra	Rate	Fee
TOTAL CLAIMS	1 - 20 =	0	x 18 =	\$0.00
INDEPENDENT CLAIMS	1 - 3 =	0	x 80 =	\$0.00
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BASIC FEE				\$710.00
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